PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|--|--|--|
| 1.1 Company STMicroelectronics International N.V | | STMicroelectronics International N.V |
| 1.2 PCN No. | | ADG/21/12814 |
| 1.3 Title of PCN | | Wafer Manufacturing & EWS capacity extension in ST Singapore for SIC 650V products |
| 1.4 Product Category | | SiC 650V products |
| 1.5 Issue date | | 2021-06-03 |

| 2. PCN Team | |
|---------------------------|-------------------------|
| 2.1 Contact supplier | |
| 2.1.1 Name | NEMETH KRISZTINA |
| 2.1.2 Phone | +49 89460062210 |
| 2.1.3 Email | krisztina.nemeth@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Stephane CHAMARD |
| 2.1.2 Marketing Manager | Philippe LEGER |
| 2.1.3 Quality Manager | Jean-Paul REBRASSE |

| 3. Change | | |
|--------------|--|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication | |

| 4. Description of change | | |
|---|--------------------|--|
| | Old | New |
| 4.1 Description | ST Catania - Italy | ST Catania - Italy ST Singapore with Process rationalization for both plants |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No | |

| 5. Reason / motivation for change | |
|-----------------------------------|--|
| 5.1 Motivation | In line with the commitment of ST Company to reinforce its leading position in the SiC Power Rectifiers market and to support strong SiC business increase, STMicroelectronics has decided to expand the manufacturing & EWS capacity of SiC 650V diodes. This additional wafer fab & EWS capacity will be done through production line located in the Singapore existing plant. |
| | ST is taking this opportunity to enhance and to standardize production flows using same metallization and thicknesses for all SiC products. |
| 5.2 Customer Benefit | CAPACITY INCREASE |

| 6. Marking of parts / traceability of change | |
|--|------------------------------|
| 6.1 Description | Finished Good and plant code |

| 7. Timing / schedule | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2021-06-01 |
| 7.2 Intended start of delivery | 2021-09-03 |
| 7.3 Qualification sample available? | Upon Request |

8. Qualification / Validation

8.1 Description

In progress

9. Attachments (additional documentations)

12814 Public product.pdf 12814 SiC 650V capacity extension in ST Singapore.pdf

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| 3498802 | STPSC10065DLF | |
| 3527113 | STPSC10H065DLF | |
| 3397857 | STPSC12065D | |
| 3018770 | STPSC4H065DLF | |
| 3018771 | STPSC6H065DLF | |
| 3018772 | STPSC8H065DLF | |

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